

N-Channel 100 V (D-S) MOSFET

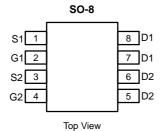
PRODUCT SUMMARY				
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)	
100	0.187 at V _{GS} = 10 V	3	7.3 nC	

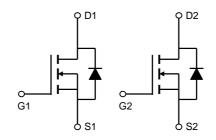
FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_q and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

DC/DC Conversion
 Notebook System Power





Absolute Maximum Ratings T _A =25 [°] C unless otherwise noted					
Parameter		Symbol	Maximum	Units	
Drain-Source Voltage	e	V _{DS}	100	V	
Gate-Source Voltage		V _{GS}	±20	V	
Continuous Drain	T _A =25℃		3.0		
Current	T _A =70℃	I _D	2.5	А	
Pulsed Drain Current ^C		I _{DM}	12		
Avalanche Current ^C		I _{AR}	3	А	
Repetitive avalanche energy L=0.1mH ^C		E _{AR}	12.8	mJ	
Power Dissipation ^B	T _A =25℃	D	2	W	
	T _A =70℃	P _D	1.3	VV	
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150	C	

Thermal Characteristics					
Parameter	Symbol	Тур	Мах	Units	
Maximum Junction-to-Ambient ^A	t ≤ 10s	Б	48	62.5	°C/W
Maximum Junction-to-Ambient AD	Steady-State	R _{θJA}	74	90	C/W
Maximum Junction-to-Lead	Steady-State	$R_{ ext{ hetaJL}}$	32	40	°C/W





Symbol	Parameter	Conditions	Min	Тур	Max	Units	
STATIC P	STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D=250\mu A, V_{GS}=0V$	100			V	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =80V, V _{GS} =0V			1	μA	
000	gg	T _J =55℃			5	pu .	
I _{GSS}	Gate-Body leakage current	$V_{DS}=0V, V_{GS}=\pm 30V$			100	nA	
V _{GS(th)}	Gate Threshold Voltage	$V_{DS}=V_{GS}$ $I_{D}=250\mu A$	1	2	3	V	
I _{D(ON)}	On state drain current	V _{GS} =10V, V _{DS} =5V	18			A	
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =2.5A		187 193.0		mΩ	
g _{FS}	Forward Transconductance	V _{DS} =5V, I _D =2.5A		193.0		S	
V _{SD}	Diode Forward Voltage	I _S =1A,V _{GS} =0V		0.77	1	V	
Is	Maximum Body-Diode Continuous Curre				2.5	А	
I _{SM}	Pulsed Body-diode Current ^C				18	А	
DYNAMIC	PARAMETERS					•	
C _{iss}	Input Capacitance		510	640	770	pF	
C _{oss}	Output Capacitance	V _{GS} =0V, V _{DS} =40V, f=1MHz	28	40	52	pF	
C _{rss}	Reverse Transfer Capacitance		12	20	30	pF	
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz	0.9	1.8	2.7	Ω	
SWITCHI	NG PARAMETERS						
Q _g (10V)	Total Gate Charge		8	11	13	nC	
Q _g (4.5V)	Total Gate Charge	V _{GS} =10V, V _{DS} =40V, I _D =2.5A	4	5.5	7		
Q _{gs}	Gate Source Charge	$v_{GS} = 10^{\circ}, v_{DS} = 40^{\circ}, i_{D} = 2.3^{\circ}$	4	5	6	nC	
Q _{gd}	Gate Drain Charge		0.7	1.2	1.7	nC	
t _{D(on)}	Turn-On DelayTime			7.2		ns	
t _r	Turn-On Rise Time	V_{GS} =10V, V_{DS} =40V, R_{L} =8 Ω ,		2.2		ns	
t _{D(off)}	Turn-Off DelayTime	$R_{GEN}=3\Omega$		17		ns	
t _f	Turn-Off Fall Time]		2		ns	
t _{rr}	Body Diode Reverse Recovery Time	I _F =2.5A, dl/dt=300A/µs	14	20	26	ns	
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =2.5A, dl/dt=300A/μs	35	50	65	nC	

Electrical Characteristics (T_J=25°C unless otherwise noted)

A. The value of $R_{\theta JA}$ is measured with the device mounted on $1in^2$ FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25$ °C. The value in any given application depends on the user's specific board design.

B. The power dissipation P_D is based on $T_{J(MAX)}=150$ °C, using ≤ 10 s junction-to-ambient thermal resistance.

C. Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}$ =150°C. Ratings are based on low frequency and duty cycles to keep initial T_{J} =25°C.

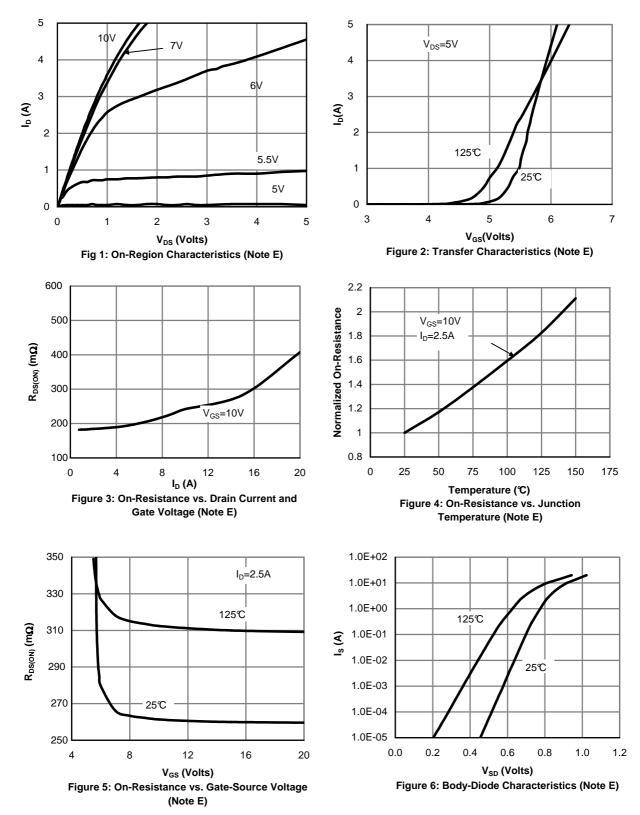
D. The $R_{\theta JA}$ is the sum of the thermal impedence from junction to lead $R_{\theta JL}$ and lead to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using <300 μ s pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-ambient thermal impedence which is measured with the device mounted on 1in² FR-4 board with

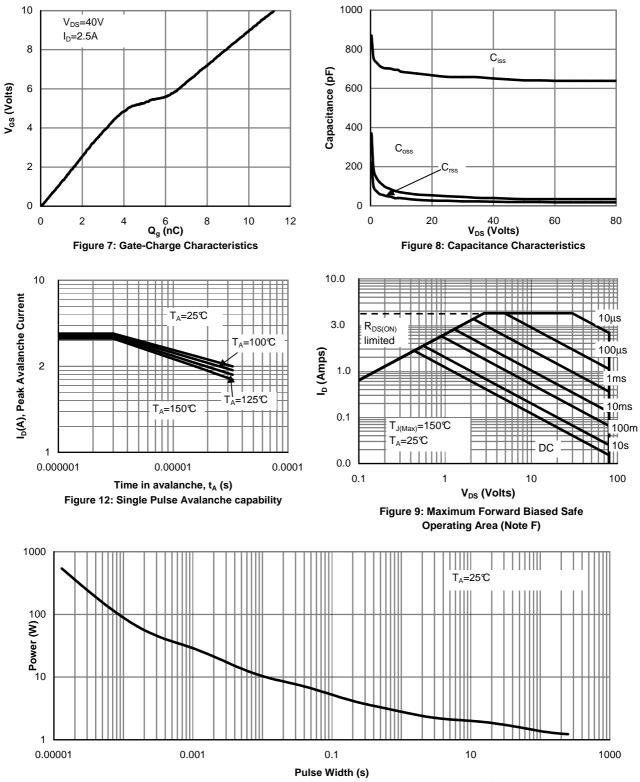


TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



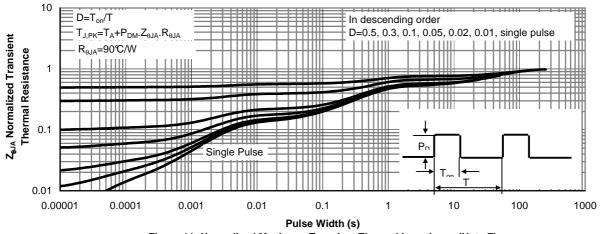


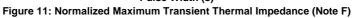
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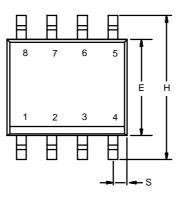
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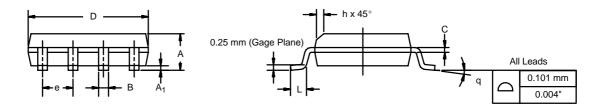






SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012

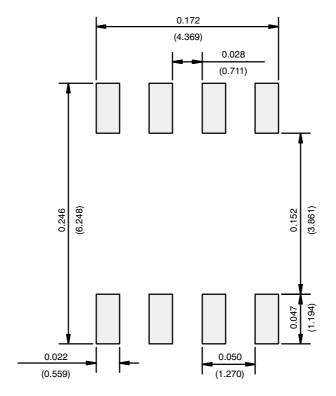




	MILLIN	IETERS	INCHES		
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27 BSC		0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)



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